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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/602,298	06/24/2003	Bernd Witzigmann	2879P	1201	
41170 7	590 06/02/2005		EXAMI	EXAMINER	
	CORPORATION NGUYEN, PHILLIP NK BLVD, S.E.				
ALBUQUERQUE, NM 87123			ART UNIT	PAPER NUMBER	
			2828		
			DATE MAILED: 06/02/2005		

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
Office Action Commons	10/602,298	WITZIGMANN ET AL.			
Office Action Summary	Examiner	Art Unit			
	Phillip Nguyen	2828			
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the c	orrespondence address			
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period of Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be tin y within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed on 14 M	larch 2005.				
2a)⊠ This action is FINAL . 2b)□ This action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under E	Ex parte Quayle, 1935 C.D. 11, 45	53 O.G. 213.			
Disposition of Claims					
4)⊠ Claim(s) <u>1-23</u> is/are pending in the application.					
4a) Of the above claim(s) is/are withdrawn from consideration.					
5) Claim(s) is/are allowed.					
6)⊠ Claim(s) <u>1-23</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/or	r election requirement.				
Application Papers					
9) The specification is objected to by the Examiner.					
10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).					
11) The oath or declaration is objected to by the Ex	caminer. Note the attached Office	Action or form PTO-152.			
Priority under 35 U.S.C. § 119					
12) ☐ Acknowledgment is made of a claim for foreign a) ☐ All b) ☐ Some * c) ☐ None of:	priority under 35 U.S.C. § 119(a)	-(d) or (f).			
 Certified copies of the priority documents have been received. 					
2. Certified copies of the priority documents have been received in Application No					
3. Copies of the certified copies of the priority documents have been received in this National Stage					
application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received.					
See the attached detailed Office action for a list	of the certified copies not receive	a.			
Attachment(s)					
1) Notice of References Cited (PTO-892)	4) Interview Summary				
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail Da				
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	6) Other:	асент Аррисавон (СТО-192)			
U.S. Patent and Trademark Office PTOL-326 (Rev. 1-04) Office Ac	etion Summary	Part of Paper No./Mail Date 051805			
Office Ac	aton ouninary	art of Faper 140./Iviali Date 001005			

Application/Control Number: 10/602,298 Page 2

Art Unit: 2828

DETAILED ACTION

Response to Arguments

1. Applicant's arguments with respect to claims 1-23 have been considered but are moot in view of the new ground(s) of rejection.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1-2, 6-8, and 10-23 are rejected under 35 U.S.C. 102(b) as being clearly anticipated by Wu ('364).

With respect to claim 1, Wu discloses in Figures 2-4D a semiconductor chip 110 comprising a ridge structure disposed between channels formed on a junction surface of the laser chip; and a plurality of pads 226 only on non-active areas of the junction surface, wherein the pads protrude beyond an edge of the ridge structure. It is noted that the active area is 210 and pads are disposed on the insulation layer 222 which is non-active area.

With respect to claim 2, Wu discloses a substrate 212 and a mounting surface (could be any surface of the laser 110 such as the lower surface of the substrate where the power source is mounted to the laser or the surface of the pads where the electrode 224 is mounted on).

With respect to claim 6, Wu shows the ridge structure protrudes beyond an edge of the junction surface.

With respect to claim 7, Wu discloses in Fig. 3D a plurality of contacts in the active area 210 such as layers 212 or 214 which are disconnected from the pads.

With respect to claim 8, Wu discloses the pad 226 is bonding pad which includes gold or gold alloy (col. 5, lines 14-16).

With respect to claim 10, Wu discloses the laser preferred bandwidth of 0.5-5 nm which is equivalent to the frequencies approximately equal to 1GHz or larger (col. 3, lines 40-42).

With respect to claim 11, Wu discloses a current source modulated in time (as shown in Fig. 2).

Claims 12-22 further recites a method for "providing" a semiconductor chip. Since Wu disclose the product, it is inherent product by process for performing a method as recited in the claims.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person

Art Unit: 2828

having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

- 3. Claims 3-5 and 23 are rejected under 35 U.S.C. 103(a) as being unpatentable over Wu et al. ('364) in view of Miyazaki ('379). With respect to claims 3-4, Wu discloses the claimed invention except for a manufacturing tool abutting the pad without abutting the ridge shape structure. Miyazaki discloses in Figures 1-2 and 7-10 an optical chip that comprising ridge shape structure having a plurality of pads 18 only on non-active areas of the junction surface wherein any manufacturing tool except being a laser chip. For the improvement, it would have been obvious to the one having ordinary skill in the art at the time the invention was made to provide a laser chip that has a plurality of pads on the non-active area as taught by Wu to keep manufacturing tool from abutting the ridge structure of the laser chip as taught by Miyazaki (col. 6, lines 20-21).
- 4. Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over Cai et al. ('254) in view of Wu ('364). Cai discloses the claimed invention as shown in Fig. 3 (and the previous Office Action) with plurality of pads comprising non-metal material (paragraph 0031) except for channels formed on a junction surface of the laser chip. Wu discloses the claimed invention as shown in the rejection of claim 1 except for the plurality of pads comprising non-metal material. For the improvement of the laser chip, it would have been obvious to the one having ordinary skill in the art at the time the invention was made to provide the channels 316, 318 as taught by Wu in order to build the ridge structure.

Conclusion

5. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Citation of Pertinent References

6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

The patent to Miyazaki discloses OPTICAL DEVICE AND ITS MANUFACTURING METHOD, U.S. Patent No. 6574379

The patent to Wu discloses Back Facet Flared Ridge For Pump Laser, U.S. Patent No. 6375364

Application/Control Number: 10/602,298

Art Unit: 2828

The Patent Application Publication to Cai et al. discloses SEMICONDUCTOR

DEVICES WITH IMPROVED HEAT DISSIPATION AND METHOD OFR

FABRICATING SAME, U.S. PG Pub No. 20040026779

The Patent Application Publication to Haneda et al. discloses Semiconductor Optical

Device, U.S. PG Pub No. 20030210721

Communication Information

7. Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Phillip Nguyen whose telephone number is 571-272-1947. The

examiner can normally be reached on 9:00 AM - 6:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, MINSUN HARVEY, can be reached on 571-272-1835. The fax phone number for

the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent

Application Information Retrieval (PAIR) system. Status information for published applications

may be obtained from either Private PAIR or Public PAIR. Status information for unpublished

applications is available through Private PAIR only. For more information about the PAIR

system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR

system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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PRIMARY EXC

Page 6